

A

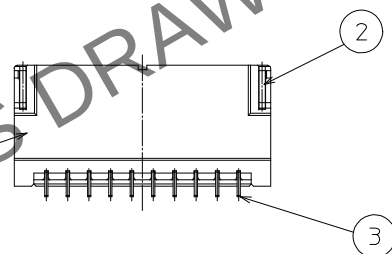
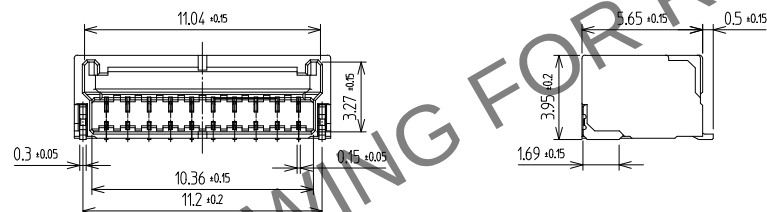
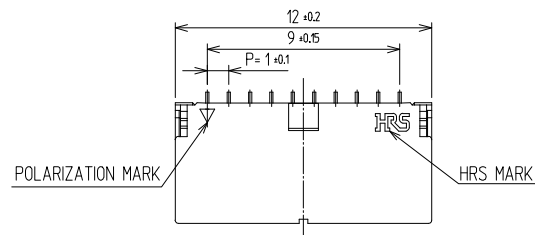
B

C

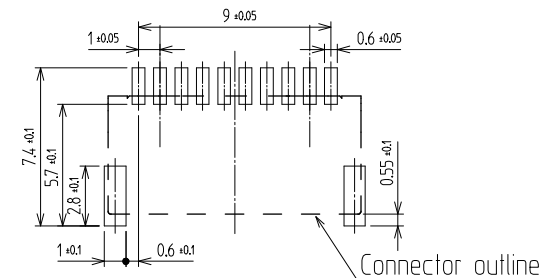
D

E

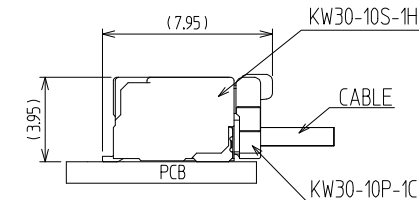
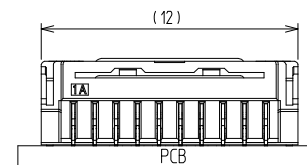
F



RECOMMENDED PCB LAYOUT (Top-View)



MATING FIGURE

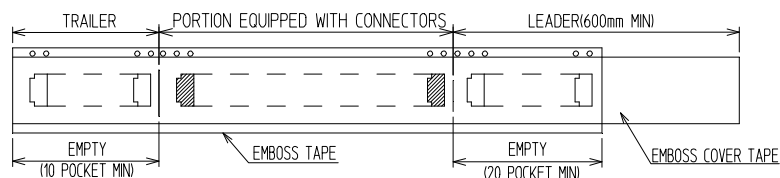
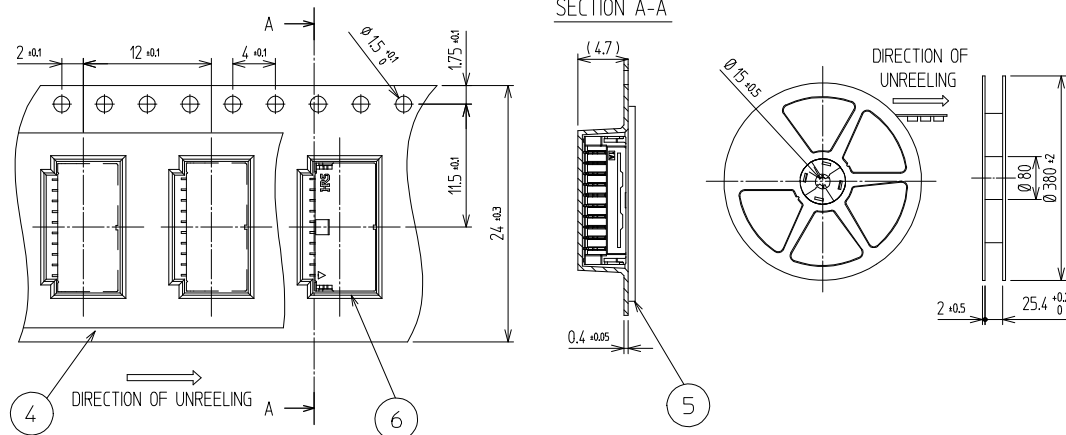


NOTE

1. LEAD CO-PLANARITY SHALL BE 0.1mmMAX
2. 1REEL : 1500EA CONNECTORS
3. UL(File No. E132750) AUTHORIZATION ARTICLE.
C-UL(File No. E132750) AUTHORIZATION ARTICLE.



SECTION A-A



3	COPPER ALLOY	CONTACT AREA : GOLD 0.2mm MIN. SMT LEAD : GOLD 0.05mm MIN. UNDER PLATING : NICKEL 1mm MIN.	6	CONNECTOR	KW30-10S-1H
2	PHOSPHOR BRONZE	Sn PLATED	5	PET	COVER TAPE
1	LCP	UL94-V0, BLACK	4	PS	EMBOSS CARRIER TAPE
NO.	MATERIAL	FINISH,REMARKS	NO.	MATERIAL	FINISH,REMARKS
CODE NO. (OLD)			DRAWN	DESIGNED	CHECKED
			CHOI 20.06.15 S.W	CHOI 20.06.15 S.W	LIM 20.06.15 S.M
			APPROVED		
			LIM 20.06.15 S.M		
			RELEASED		
DRAWING NO.			PART NO.		
EDC3-633094			KW30-10S-1H (800)		
SCALE			CODE NO.		
4:1			CL 6669-0011-7-800		
UNITS					
mm					